

# SCAN182373A

## Transparent Latch with 25Ω Series Resistor Outputs

### General Description

The SCAN182373A is a high performance BiCMOS transparent latch featuring separate data inputs organized into dual 9-bit bytes with byte-oriented latch enable and output enable control signals. This device is compliant with IEEE 1149.1 Standard Test Access Port and Boundary-Scan Architecture with the incorporation of the defined boundary-scan test logic and test access port consisting of Test Data Input (TDI), Test Data Out (TDO), Test Mode Select (TMS), and Test Clock (TCK).

### Features

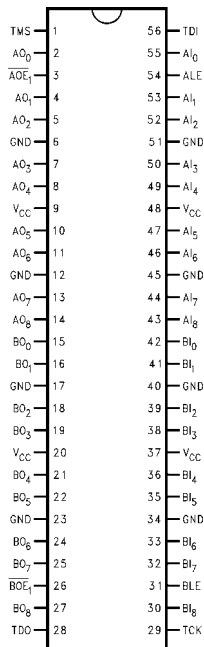
- IEEE 1149.1 (JTAG) Compliant
- High performance BiCMOS technology
- 25Ω series resistor outputs eliminate need for external terminating resistors
- Buffered active-low latch enable
- 3-STATE outputs for bus-oriented applications
- 25 mil pitch SSOP (Shrink Small Outline Package)
- Includes CLAMP, IDCODE and HIGHZ instructions
- Additional instructions SAMPLE-IN, SAMPLE-OUT and EXTEST-OUT
- Power up 3-STATE for hot insert
- Member of Fairchild's SCAN Products

### Ordering Code:

| Order Number   | Package Number | Package Description   |
|----------------|----------------|---|
| SCAN182373ASSC | MS56A          | 56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### Connection Diagram



### Pin Descriptions

| Pin Names                           | Description                  |
|-------------------------------------|------------------------------|
| AI(0-8), BI(0-8)                    | Data Inputs                  |
| ALE, BLE                            | Latch Enable Inputs          |
| AOE <sub>1</sub> , BOE <sub>1</sub> | 3-STATE Output Enable Inputs |
| AO(0-8), BO(0-8)                    | 3-STATE Latch Outputs        |

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## Truth Tables

| Inputs |                             |          | AO (0–8)        |
|--------|-----------------------------|----------|-----------------|
| ALE    | $\uparrow \overline{AOE_1}$ | AI (0–8) |                 |
| X      | H                           | X        | Z               |
| H      | L                           | L        | L               |
| H      | L                           | H        | H               |
| L      | L                           | X        | AO <sub>0</sub> |

H = HIGH Voltage Level  
 L = LOW Voltage Level  
 X = Immaterial  
 Z = High Impedance

| Inputs |                             |          | BO (0–8)        |
|--------|-----------------------------|----------|-----------------|
| BLE    | $\uparrow \overline{BOE_1}$ | BI (0–8) |                 |
| X      | H                           | X        | Z               |
| H      | L                           | L        | L               |
| H      | L                           | H        | H               |
| L      | L                           | X        | BO <sub>0</sub> |

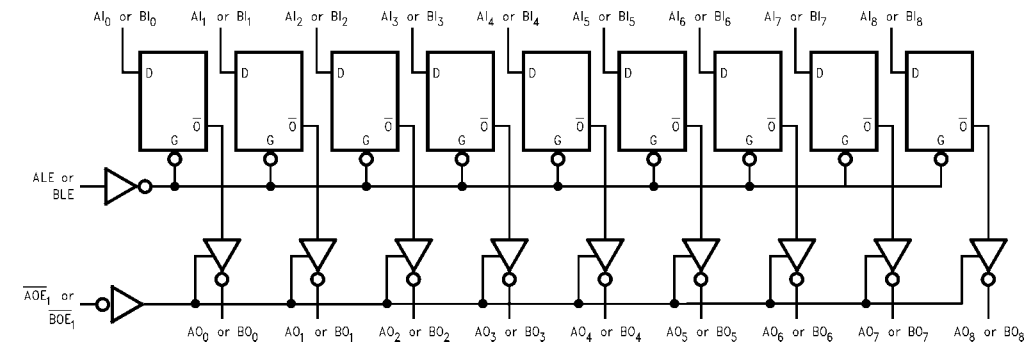
AO<sub>0</sub> = Previous AO before H-to-L transition of ALE  
 BO<sub>0</sub> = Previous BO before H-to-L transition of BLE  
 $\uparrow$  = Inactive-to-active transition must occur to enable outputs upon power-up.

## Functional Description

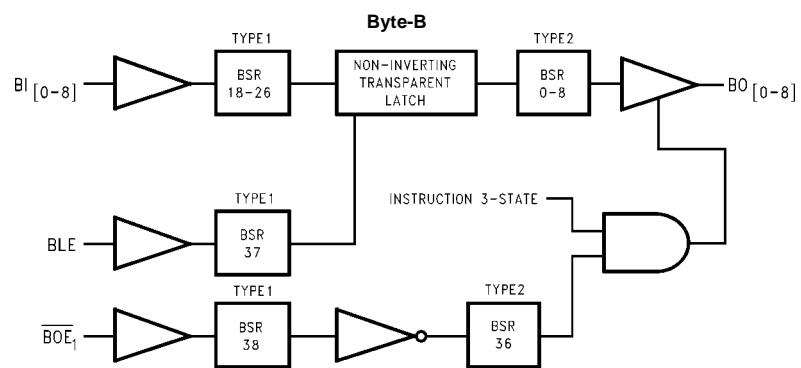
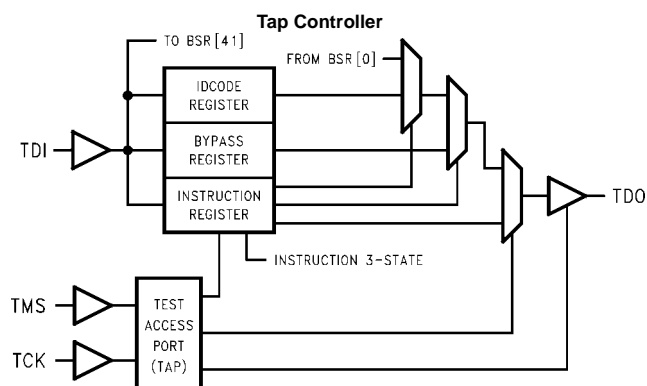
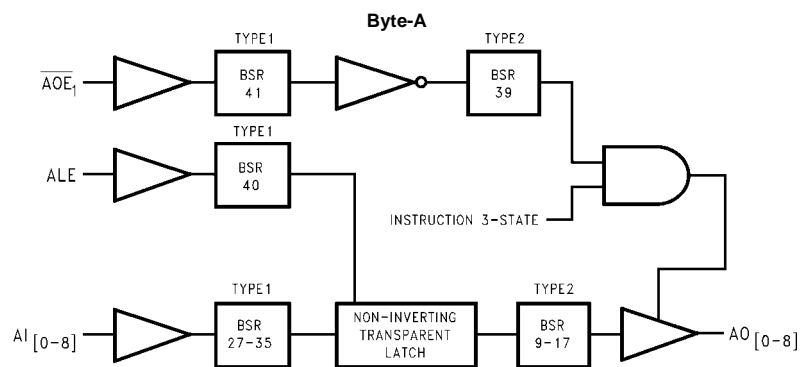
The SCAN182373A consists of two sets of nine D-type latches with 3-STATE standard outputs. When the Latch Enable (ALE or BLE) input is HIGH, data on the inputs (AI<sub>(0–8)</sub> or BI<sub>(0–8)</sub>) enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its input changes. When Latch Enable is LOW, the latches store the information that was present on

the inputs a set-up time preceding the HIGH-to-LOW transition of the Latch Enable. The 3-STATE standard outputs are controlled by the Output Enable ( $\overline{AOE_1}$  or  $\overline{BOE_1}$ ) input. When Output Enable is LOW, the standard outputs are in the 2-state mode. When Output Enable is HIGH, the standard outputs are in the high impedance mode, but this does not interfere with entering new data into the latches.

## Logic Diagram



# Block Diagrams



**Note:** BSR stands for Boundary Scan Register.

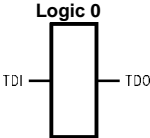
# Description of BOUNDARY-SCAN Circuitry

The scan cells used in the BOUNDARY-SCAN register are one of the following two types depending upon their location. Scan cell TYPE1 is intended to solely observe system data, while TYPE2 has the additional ability to control system data.

Scan cell TYPE 1 is located on each system input pin while scan cell TYPE2 is located at each system output pin as well as at each of the two internal active-high output enable signals. AOE controls the activity of the A-outputs while BOE controls the activity of the B-outputs. Each will activate their respective outputs by loading a logic high.

The BYPASS register is a single bit shift register stage identical to scan cell TYPE1. It captures a fixed logic low.

## Bypass Register Scan Chain Definition

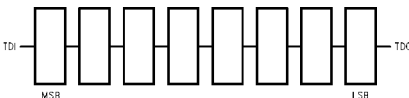


## SCAN182373A Product IDCODE (32-Bit Code per IEEE 1149.1)

| Version | Entity | Part Number | Manufacturer ID | Required by 1149.1 |
|---------|--------|-------------|-----------------|--------------------|
| 0000    | 111111 | 0000001000  | 00000001111     | 1                  |
| MSB     |        | LSB         |                 |                    |

The INSTRUCTION register is an 8-bit register which captures the default value of 10000001 (SAMPLE/PRELOAD) during the CAPTURE-IR instruction command. The benefit of capturing SAMPLE/PRELOAD as the default instruction during CAPTURE-IR is that the user is no longer required to shift in the 8-bit instruction for SAMPLE/PRELOAD. The sequence of: CAPTURE-IR → EXIT1-IR → UPDATE-IR will update the SAMPLE/PRELOAD instruction. For more information refer to the section on instruction definitions.

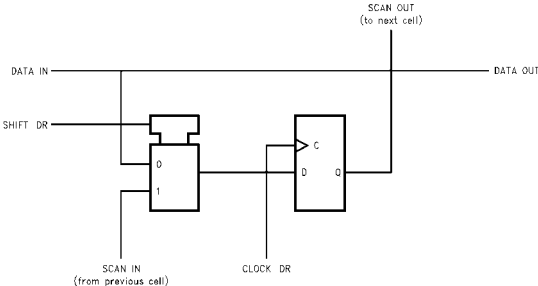
## Instruction Register Scan Chain Definition



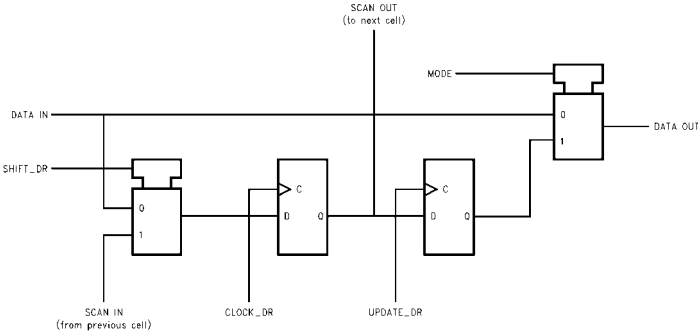
## MSB → LSB

| Instruction Code | Instruction    |
|------------------|----------------|
| 00000000         | EXTEST         |
| 10000001         | SAMPLE/PRELOAD |
| 10000010         | CLAMP          |
| 00000011         | HIGH-Z         |
| 01000001         | SAMPLE-IN      |
| 01000010         | SAMPLE-OUT     |
| 00100010         | EXTEST-OUT     |
| 10101010         | IDCODE         |
| 11111111         | BYPASS         |
| All Others       | BYPASS         |

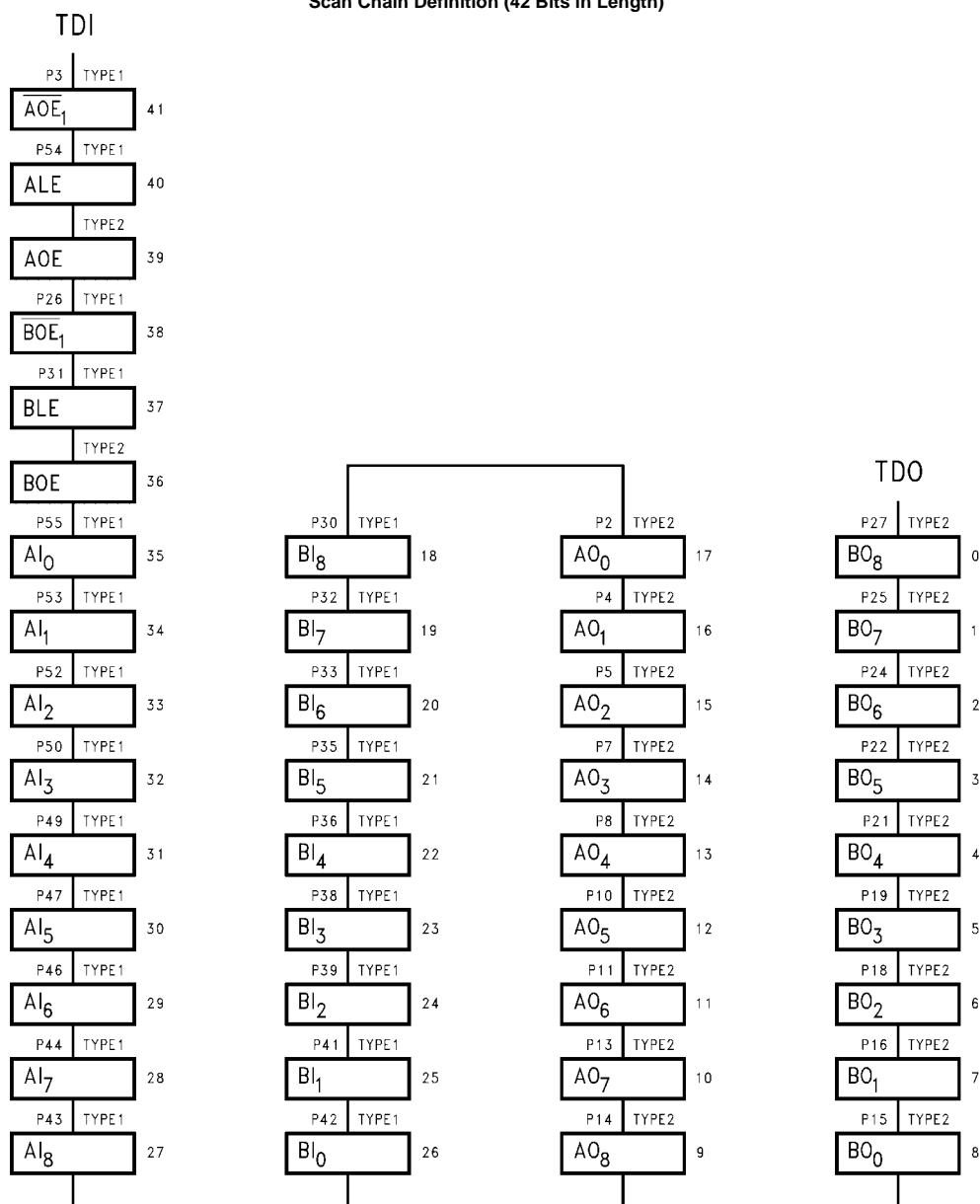
## Scan Cell TYPE1



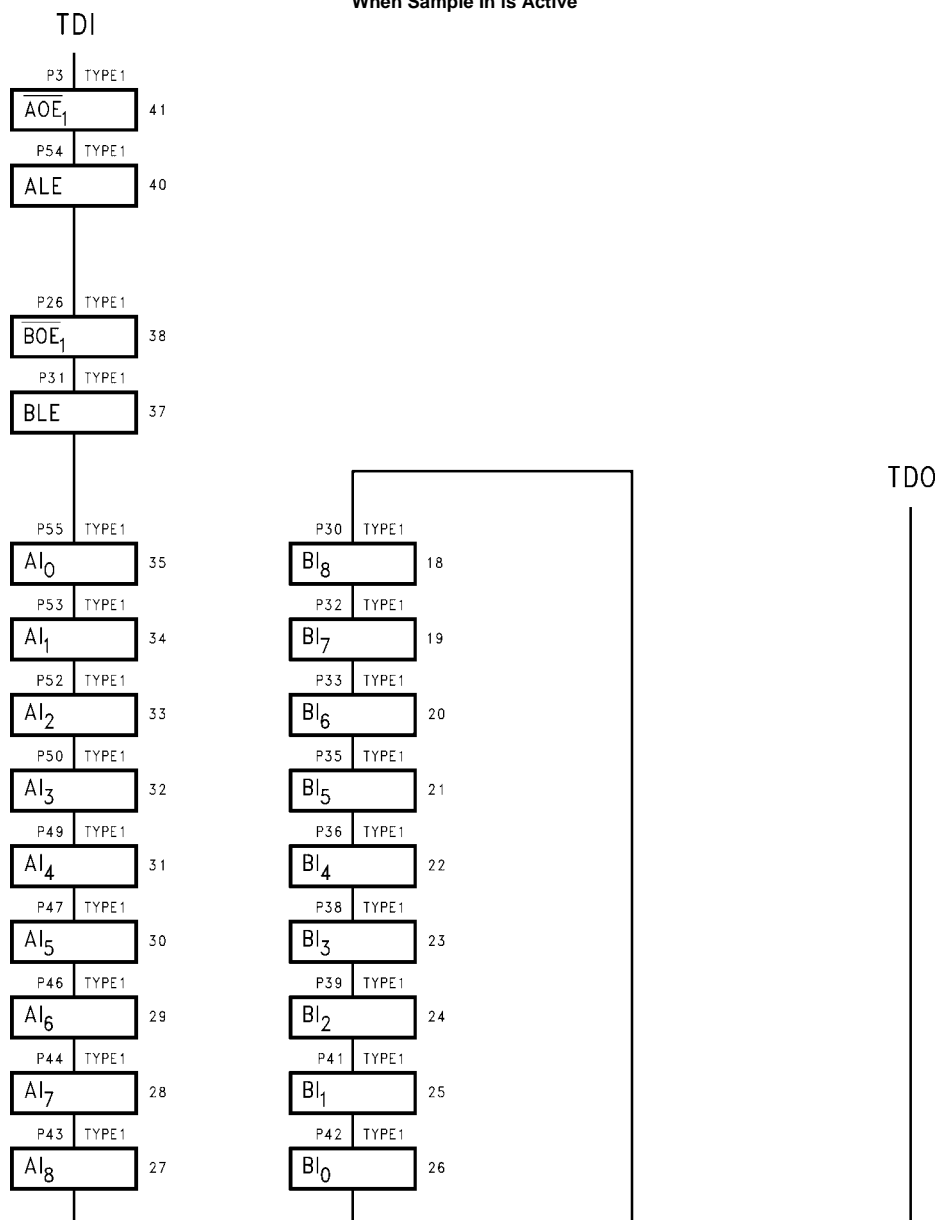
## Scan Cell TYPE2



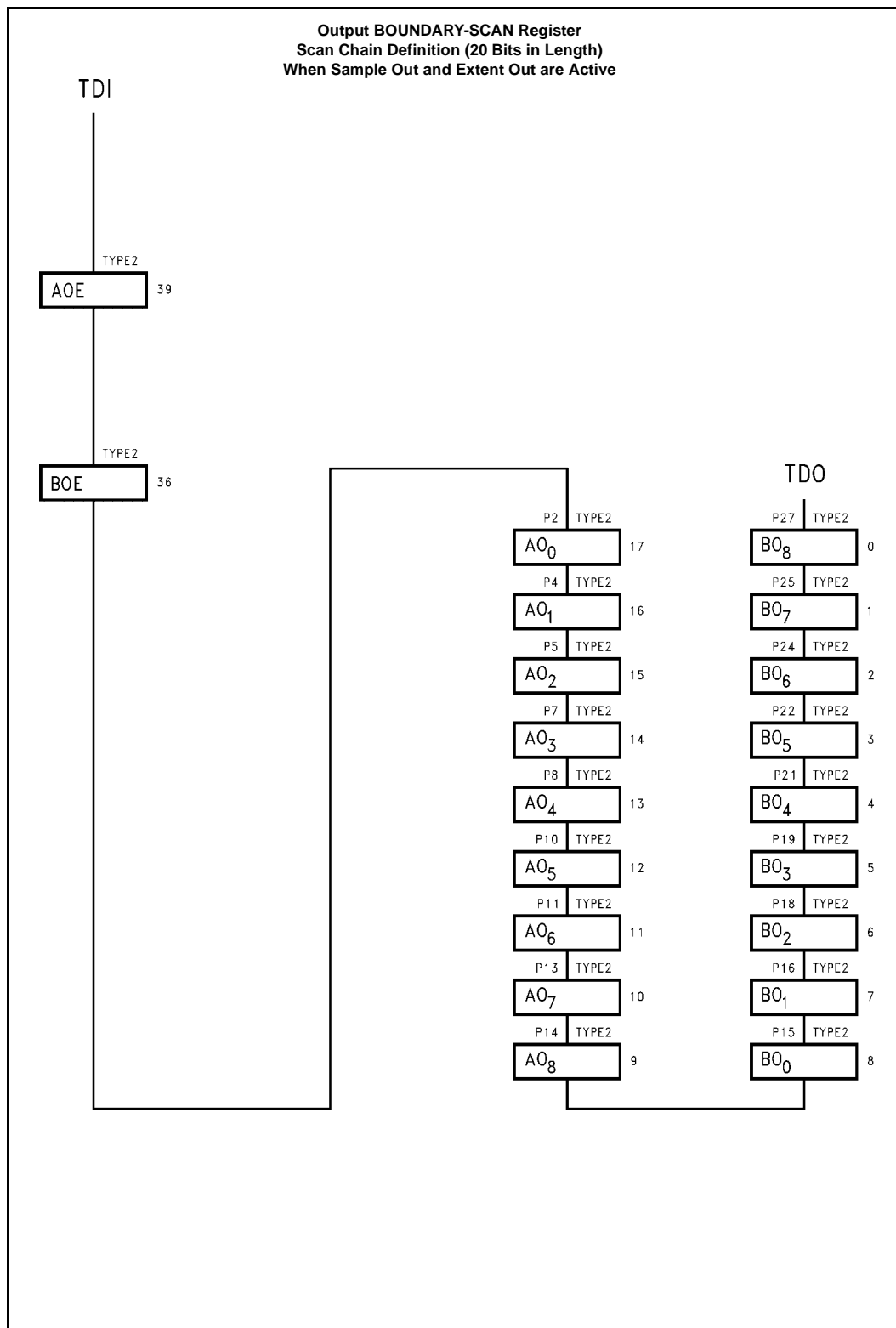
**BOUNDARY-SCAN Register**  
**Scan Chain Definition (42 Bits in Length)**



Input BOUNDARY-SCAN Register  
Scan Chain Definition (22 Bits in Length)  
When Sample In is Active



Output BOUNDARY-SCAN Register  
Scan Chain Definition (20 Bits in Length)  
When Sample Out and Extent Out are Active



BOUNDARY-SCAN Register Definition Index

| Bit No. | Pin Name           | Pin No. | Pin Type | Scan Cell Type |                 |
|---------|--------------------|---------|----------|----------------|-----------------|
| 41      | $\overline{AOE}_1$ | 3       | Input    | TYPE1          | Control Signals |
| 40      | ALE                | 54      | Input    | TYPE1          |                 |
| 39      | AOE                |         | Internal | TYPE2          |                 |
| 38      | $\overline{BOE}_1$ | 26      | Input    | TYPE1          |                 |
| 37      | BLE                | 31      | Input    | TYPE1          |                 |
| 36      | BOE                |         | Internal | TYPE2          |                 |
| 35      | AI <sub>0</sub>    | 55      | Input    | TYPE1          | A-in            |
| 34      | AI <sub>1</sub>    | 53      | Input    | TYPE1          |                 |
| 33      | AI <sub>2</sub>    | 52      | Input    | TYPE1          |                 |
| 32      | AI <sub>3</sub>    | 50      | Input    | TYPE1          |                 |
| 31      | AI <sub>4</sub>    | 49      | Input    | TYPE1          |                 |
| 30      | AI <sub>5</sub>    | 47      | Input    | TYPE1          |                 |
| 29      | AI <sub>6</sub>    | 46      | Input    | TYPE1          |                 |
| 28      | AI <sub>7</sub>    | 44      | Input    | TYPE1          |                 |
| 27      | AI <sub>8</sub>    | 43      | Input    | TYPE1          |                 |
| 26      | BI <sub>0</sub>    | 42      | Input    | TYPE1          | B-in            |
| 25      | BI <sub>1</sub>    | 41      | Input    | TYPE1          |                 |
| 24      | BI <sub>2</sub>    | 39      | Input    | TYPE1          |                 |
| 23      | BI <sub>3</sub>    | 38      | Input    | TYPE1          |                 |
| 22      | BI <sub>4</sub>    | 36      | Input    | TYPE1          |                 |
| 21      | BI <sub>5</sub>    | 35      | Input    | TYPE1          |                 |
| 20      | BI <sub>6</sub>    | 33      | Input    | TYPE1          |                 |
| 19      | BI <sub>7</sub>    | 32      | Input    | TYPE1          |                 |
| 18      | BI <sub>8</sub>    | 30      | Input    | TYPE1          |                 |
| 17      | AO <sub>0</sub>    | 2       | Output   | TYPE2          | A-out           |
| 16      | AO <sub>1</sub>    | 4       | Output   | TYPE2          |                 |
| 15      | AO <sub>2</sub>    | 5       | Output   | TYPE2          |                 |
| 14      | AO <sub>3</sub>    | 7       | Output   | TYPE2          |                 |
| 13      | AO <sub>4</sub>    | 8       | Output   | TYPE2          |                 |
| 12      | AO <sub>5</sub>    | 10      | Output   | TYPE2          |                 |
| 11      | AO <sub>6</sub>    | 11      | Output   | TYPE2          |                 |
| 10      | AO <sub>7</sub>    | 13      | Output   | TYPE2          |                 |
| 9       | AO <sub>8</sub>    | 14      | Output   | TYPE2          |                 |
| 8       | BO <sub>0</sub>    | 15      | Output   | TYPE2          | B-out           |
| 7       | BO <sub>1</sub>    | 16      | Output   | TYPE2          |                 |
| 6       | BO <sub>2</sub>    | 18      | Output   | TYPE2          |                 |
| 5       | BO <sub>3</sub>    | 19      | Output   | TYPE2          |                 |
| 4       | BO <sub>4</sub>    | 21      | Output   | TYPE2          |                 |
| 3       | BO <sub>5</sub>    | 22      | Output   | TYPE2          |                 |
| 2       | BO <sub>6</sub>    | 24      | Output   | TYPE2          |                 |
| 1       | BO <sub>7</sub>    | 25      | Output   | TYPE2          |                 |
| 0       | BO <sub>8</sub>    | 27      | Output   | TYPE2          |                 |



**Absolute Maximum Ratings**(Note 1)

|   |                                      |
|---|--------------------------------------|
| Storage Temperature                         | –65°C to +150°C                      |
| Ambient Temperature under Bias              | –55°C to +125°C                      |
| Junction Temperature under Bias             | –55°C to +150°C                      |
| V <sub>CC</sub> Pin Potential to Ground Pin | –0.5V to +7.0V                       |
| Input Voltage (Note 2)                      | –0.5V to +7.0V                       |
| Input Current (Note 2)                      | –30 mA to +5.0 mA                    |
| Voltage Applied to Any Output               |                                      |
| in Disabled or Power-Off State              | –0.5V to +5.5V                       |
| in the HIGH State                           | –0.5V to V <sub>CC</sub>             |
| Current Applied to Output                   |                                      |
| in LOW State (Max)                          | Twice the Rated I <sub>OL</sub> (mA) |
| DC Latchup Source Current                   | –500 mA                              |
| Over Voltage Latchup (I/O)                  | 10V                                  |
| ESD (HBM) Min                               | 2000V                                |

**Recommended Operating Conditions**

|                              |                         |
|------------------------------|-------------------------|
| Free Air Ambient Temperature | –40°C to +85°C          |
| Supply Voltage               | +4.5V to +5.5V          |
| Minimum Input Edge Rate      | ( $\Delta V/\Delta t$ ) |
| Data Input                   | 50 mV/ns                |
| Enable Input                 | 20 mV/ns                |

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

**DC Electrical Characteristics**

| Symbol                             | Parameter                               |                  | V <sub>CC</sub> | Min  | Typ | Max  | Units      | Conditions  |
|------------------------------------|---|------------------|-----------------|------|-----|------|------------|---|
| V <sub>IH</sub>                    | Input HIGH Voltage                      |                  |                 | 2.0  |     |      | V          | Recognized HIGH Signal  |
| V <sub>IL</sub>                    | Input LOW Voltage                       |                  |                 |      |     | 0.8  | V          | Recognized LOW Signal   |
| V <sub>CD</sub>                    | Input Clamp Diode Voltage Output        |                  | Min             |      |     | −1.2 | V          | I <sub>IN</sub> = −18 mA  |
| V <sub>OH</sub>                    | HIGH Voltage                            |                  | Min             | 2.5  |     |      | V          | I <sub>OH</sub> = −3 mA   |
|                                    |   |                  | Min             | 2.0  |     |      | V          | I <sub>OH</sub> = −32 mA  |
| V <sub>OL</sub>                    | Output LOW Voltage                      |                  | Min             |      |     | 0.8  | V          | I <sub>OL</sub> = 15 mA   |
| I <sub>IH</sub>                    | Input HIGH Current                      | All Others       | Max             |      |     | 5    | μA         | V <sub>IN</sub> = 2.7V (Note 3)                                 |
|                                    |   |                  | Max             |      |     | 5    | μA         | V <sub>IN</sub> = V <sub>CC</sub>                               |
|                                    |   | TMS, TDI         | Max             |      |     | 5    | μA         | V <sub>IN</sub> = V <sub>CC</sub>                               |
| I <sub>BVI</sub>                   | Input HIGH Current Breakdown Test       |                  | Max             |      |     | 7    | μA         | V <sub>IN</sub> = 7.0V  |
| I <sub>BVIT</sub>                  | Input HIGH Current Breakdown Test (I/O) |                  | Max             |      |     | 100  | μA         | V <sub>IN</sub> = 5.5V  |
| I <sub>IL</sub>                    | Input LOW Current                       | All Others       | Max             |      |     | −5   | μA         | V <sub>IN</sub> = 0.5V (Note 3)                                 |
|                                    |   |                  | Max             |      |     | −5   | μA         | V <sub>IN</sub> = 0.0V  |
|                                    |   | TMS, TDI         | Max             |      |     | −385 | μA         | V <sub>IN</sub> = 0.0V  |
| V <sub>ID</sub>                    | Input Leakage Test                      |                  | 0.0             | 4.75 |     |      | V          | I <sub>ID</sub> = 1.9 μA<br>All Other Pins Grounded             |
| I <sub>IH</sub> + I <sub>OZH</sub> | Output Leakage Current                  |                  | Max             |      |     | 50   | μA         | V <sub>OUT</sub> = 2.7V   |
| I <sub>IL</sub> + I <sub>OZL</sub> | Output Leakage Current                  |                  | Max             |      |     | −50  | μA         | V <sub>OUT</sub> = 0.5V   |
| I <sub>OZH</sub>                   | Output Leakage Current                  |                  | Max             |      |     | 50   | μA         | V <sub>OUT</sub> = 2.7V   |
| I <sub>OZL</sub>                   | Output Leakage Current                  |                  | Max             |      |     | −50  | μA         | V <sub>OUT</sub> = 0.5V   |
| I <sub>OS</sub>                    | Output Short-Circuit Current            |                  | Max             | −100 |     | −275 | mA         | V <sub>OUT</sub> = 0.0V   |
| I <sub>CEX</sub>                   | Output HIGH Leakage Current             |                  | Max             |      |     | 50   | μA         | V <sub>OUT</sub> = V <sub>CC</sub>                              |
| I <sub>ZZ</sub>                    | Bus Drainage Test                       |                  | 0.0             |      |     | 100  | μA         | V <sub>OUT</sub> = 5.5V<br>All Others Grounded                  |
| I <sub>CCH</sub>                   | Power Supply Current                    |                  | Max             |      |     | 250  | μA         | V <sub>OUT</sub> = V <sub>CC</sub> ; TDI, TMS = V <sub>CC</sub> |
|                                    |   |                  | Max             |      |     | 1.0  | mA         | V <sub>OUT</sub> = V <sub>CC</sub> ; TDI, TMS = GND             |
| I <sub>CCL</sub>                   | Power Supply Current                    |                  | Max             |      |     | 65   | mA         | V <sub>OUT</sub> = LOW; TDI, TMS = V <sub>CC</sub>              |
|                                    |   |                  | Max             |      |     | 65.8 | mA         | V <sub>OUT</sub> = LOW; TDI, TMS = GND                          |
| I <sub>CCZ</sub>                   | Power Supply Current                    |                  | Max             |      |     | 250  | μA         | TDI, TMS = V <sub>CC</sub>                                      |
|                                    |   |                  | Max             |      |     | 1.0  | mA         | TDI, TMS = GND  |
| I <sub>CCT</sub>                   | Additional I <sub>CC</sub> /Input       | All Other Inputs | Max             |      |     | 2.9  | mA         | V <sub>IN</sub> = V <sub>CC</sub> −2.1V                         |
|                                    |   | TDI, TMS Inputs  | Max             |      |     | 3    | mA         | V <sub>IN</sub> = V <sub>CC</sub> −2.1V                         |
| I <sub>CCD</sub>                   | Dynamic I <sub>CC</sub>                 | No Load          | Max             |      |     | 0.2  | mA/<br>MHz | Outputs Open<br>One Bit Toggling, 50% Duty Cycle                |

**Note 3:** Guaranteed not tested.

## AC Electrical Characteristics

Normal Operation:

| Symbol                               | Parameter                    | V <sub>CC</sub><br>(V)<br>(Note 4) | T <sub>A</sub> = -40°C to +85°C<br>C <sub>L</sub> = 50 pF |            |             | Units |
|--------------------------------------|------------------------------|------------------------------------|---|------------|-------------|-------|
|                                      |                              |                                    | Min   | Typ        | Max         |       |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>D to Q  | 5.0                                | 1.2<br>2.0  | 3.7<br>4.5 | 6.5<br>7.4  | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>LE to Q | 5.0                                | 1.3<br>1.8  | 4.1<br>4.5 | 7.4<br>7.3  | ns    |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Disable Time                 | 5.0                                | 1.6<br>1.8  | 4.9<br>6.0 | 9.0<br>10.7 | ns    |
| t <sub>PZL</sub><br>t <sub>PZH</sub> | Enable Time                  | 5.0                                | 1.6<br>1.0  | 6.0<br>5.0 | 9.5<br>9.3  | ns    |

Note 4: Voltage Range 5.0V ± 0.5V

## AC Operating Requirements

Normal Operation:

| Symbol         | Parameter                        | V <sub>CC</sub><br>(V)<br>(Note 5) | T <sub>A</sub> = -40°C to +85°C<br>C <sub>L</sub> = 50 pF | Units |
|----------------|----------------------------------|------------------------------------|---|-------|
|                |                                  |                                    | Guaranteed Minimum  |       |
| t <sub>S</sub> | Setup Time, H or L<br>Data to LE | 5.0                                | 1.7   | ns    |
| t <sub>H</sub> | Hold Time, H or L<br>LE to Data  | 5.0                                | 1.6   | ns    |
| t <sub>W</sub> | LE Pulse Width                   | 5.0                                | 2.3   | ns    |

Note 5: Voltage Range 5.0V ± 0.5V

## AC Electrical Characteristics

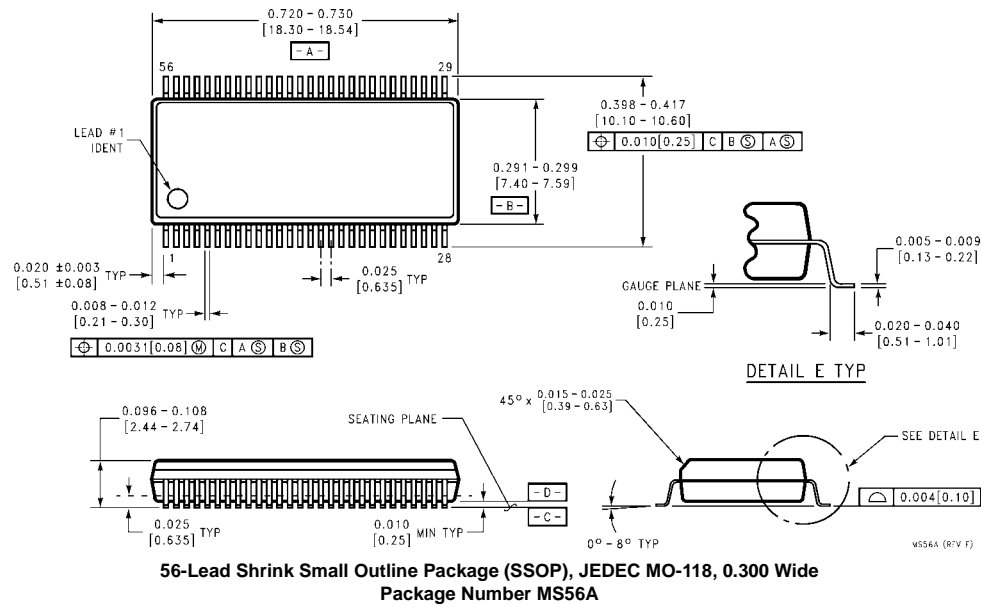
Scan Test Operation:

| Symbol                               | Parameter  | V <sub>CC</sub><br>(V)<br>(Note 6) | T <sub>A</sub> = -40°C to +85°C<br>C <sub>L</sub> = 50 pF |              |              | Units |
|--------------------------------------|--|------------------------------------|---|--------------|--------------|-------|
|                                      |  |                                    | Min   | Typ          | Max          |       |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>TCK to TDO                                    | 5.0                                | 3.6<br>4.8  | 5.8<br>7.4   | 8.6<br>10.6  | ns    |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Disable Time<br>TCK to TDO   | 5.0                                | 2.7<br>4.0  | 5.6<br>7.1   | 9.0<br>10.9  | ns    |
| t <sub>PZL</sub><br>t <sub>PZH</sub> | Enable Time<br>TCK to TDO  | 5.0                                | 5.2<br>3.6  | 8.6<br>6.6   | 12.5<br>10.1 | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>TCK to Data Out during Update-DR State        | 5.0                                | 3.9<br>5.1  | 6.4<br>8.0   | 9.5<br>11.6  | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>TCK to Data Out during Update-IR State        | 5.0                                | 4.7<br>5.7  | 7.7<br>9.1   | 11.3<br>13.1 | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>TCK to Data Out during Test Logic Reset State | 5.0                                | 5.5<br>6.7  | 9.2<br>10.7  | 13.6<br>15.6 | ns    |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Disable Time<br>TCK to Data Out during Update-DR State             | 5.0                                | 4.1<br>4.7  | 7.7<br>8.4   | 12.1<br>12.7 | ns    |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Disable Time<br>TCK to Data Out during Update-IR State             | 5.0                                | 4.2<br>4.7  | 8.3<br>9.0   | 13.5<br>14.0 | ns    |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Disable Time<br>TCK to Data Out during Test Logic Reset State      | 5.0                                | 5.5<br>6.3  | 10.1<br>10.8 | 15.6<br>16.2 | ns    |
| t <sub>PZL</sub><br>t <sub>PZH</sub> | Enable Time<br>TCK to Data Out during Update-DR State              | 5.0                                | 5.8<br>4.3  | 9.6<br>7.7   | 14.2<br>11.7 | ns    |
| t <sub>PZL</sub><br>t <sub>PZH</sub> | Enable Time<br>TCK to Data Out during Update-IR State              | 5.0                                | 6.1<br>4.7  | 11.0<br>9.0  | 16.0<br>13.7 | ns    |
| t <sub>PZL</sub><br>t <sub>PZH</sub> | Enable Time<br>TCK to Data Out during Test Logic Reset State       | 5.0                                | 7.3<br>5.8  | 12.5<br>10.5 | 18.3<br>15.8 | ns    |

Note 6: Voltage Range 5.0V ± 0.5V

| AC Operating Requirements   |   |                                    |   |                                   |
|---|---|------------------------------------|---|-----------------------------------|
| Scan Test Operation:  |   |                                    |   |                                   |
| Symbol  | Parameter   | V <sub>CC</sub><br>(V)<br>(Note 7) | T <sub>A</sub> = -40°C to +85°C<br>C <sub>L</sub> = 50 pF | Units                             |
|   |   |                                    | Guaranteed Minimum  |                                   |
| t <sub>S</sub>  | Setup Time,<br>Data to TCK (Note 8)                                       | 5.0                                | 2.7   | ns                                |
| t <sub>H</sub>  | Hold Time,<br>Data to TCK (Note 8)  | 5.0                                | 2.4   | ns                                |
| t <sub>S</sub>  | Setup Time, H or L<br>AOE <sub>1</sub> , BOE <sub>1</sub> to TCK (Note 9) | 5.0                                | 5.1   | ns                                |
| t <sub>H</sub>  | Hold Time, H or L<br>TCK to AOE <sub>1</sub> , BOE <sub>1</sub> (Note 9)  | 5.0                                | 1.8   | ns                                |
| t <sub>S</sub>  | Setup Time, H or L<br>Internal AOE, BOE, to TCK (Note 10)                 | 5.0                                | 3.5   | ns                                |
| t <sub>H</sub>  | Hold Time, H or L<br>TCK to Internal<br>AOE, BOE (Note 10)                | 5.0                                | 1.8   | ns                                |
| t <sub>S</sub>  | Setup Time<br>ALE, BLE (Note 11) to TCK                                   | 5.0                                | 5.1   | ns                                |
| t <sub>H</sub>  | Hold Time<br>TCK to ALE, BLE (Note 11)                                    | 5.0                                | 1.8   | ns                                |
| t <sub>S</sub>  | Setup Time, H or L<br>TMS to TCK  | 5.0                                | 7.9   | ns                                |
| t <sub>H</sub>  | Hold Time, H or L<br>TCK to TMS   | 5.0                                | 1.8   | ns                                |
| t <sub>S</sub>  | Setup Time, H or L<br>TDI to TCK  | 5.0                                | 6.0   | ns                                |
| t <sub>H</sub>  | Hold Time, H or L<br>TCK to TDI   | 5.0                                | 3.0   | ns                                |
| t <sub>W</sub>  | Pulse Width TCK   | H<br>L                             | 10.3<br>10.3  | ns                                |
| f <sub>MAX</sub>  | Maximum TCK Clock Frequency   | 5.0                                | 50  | MHz                               |
| t <sub>PU</sub>   | Wait Time, Power Up to TCK  | 5.0                                | 100   | ns                                |
| t <sub>DN</sub>   | Power Down Delay  | 0.0                                | 100   | ms                                |
| <b>Note 7:</b> Voltage Range 5.0V ± 0.5V.<br><b>Note 8:</b> This delay represents the timing relationship between the data input and TCK at the associated scan cells numbered 0-8, 9-17, 18-26 and 27-35.<br><b>Note 9:</b> Timing pertains to BSR 38 and 41 only.<br><b>Note 10:</b> This delay represents the timing relationship between AOE/BOE and TCK for scan cells 36 and 39 only.<br><b>Note 11:</b> Timing pertains to BSR 37 and 40 only.<br><b>Note:</b> All Input Timing Delays involving TCK are measured from the rising edge of TCK. |   |                                    |   |                                   |
| Capacitance   |   |                                    |   |                                   |
| Symbol  | Parameter   | Typ                                | Units   | Conditions, T <sub>A</sub> = 25°C |
| C <sub>IN</sub>   | Input Capacitance   | 5.8                                | pF  | V <sub>CC</sub> = 0.0V            |
| C <sub>OUT</sub>  | Output Capacitance (Note 12)  | 13.8                               | pF  | V <sub>CC</sub> = 5.0V            |
| <b>Note 12:</b> C <sub>OUT</sub> is measured at frequency f = 1 MHz, per MIL-STD-883B, Method 3012  |   |                                    |   |                                   |

## Physical Dimensions inches (millimeters) unless otherwise noted



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